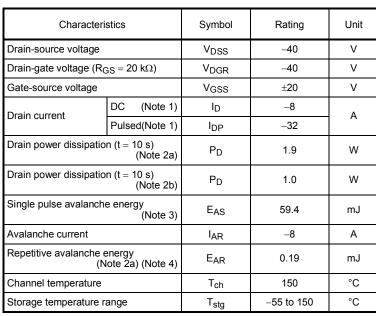
TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (U-MOS III)

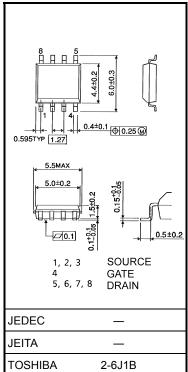
# **TPC8110**

Lithium Ion Battery Applications Notebook PC Applications Portable Equipment Applications

- Small footprint due to small and thin package •
- Low drain-source ON resistance:  $R_{DS}$  (ON) = 17 m $\Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 16 \text{ S}$  (typ.)
- Low leakage current:  $I_{DSS} = -10 \ \mu A \ (max) \ (V_{DS} = -40 \ V)$
- Enhancement mode:  $V_{th}$  = -0.8 to -2.0 V ( $V_{DS}$  = -10 V,  $I_D$  = -1 mA)

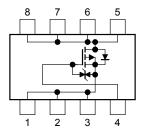


#### Absolute Maximum Ratings (Ta = 25°C)



Weight: 0.080 g (typ.)

#### **Circuit Configuration**



Note: (Note 1), (Note 2), (Note 3) and (Note 4): See the next page.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

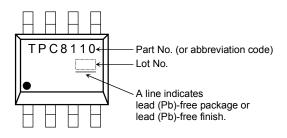
This transistor is an electrostatic-sensitive device. Please handle with caution.

Unit: mm

#### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R <sub>th (ch-a)</sub>	65.8	°C/W
$\begin{array}{l} \mbox{Thermal resistance, channel to ambient} \\ (t=10 \ s) \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ $	R <sub>th (ch-a)</sub>	125	°C/W

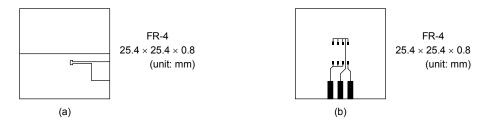
#### Marking (Note 5)



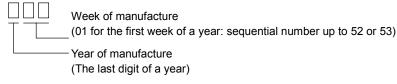
Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2:

(a) Device mounted on a glass-epoxy board (a) (b) Device mounted on a glass-epoxy board (b)



- Note 3:  $V_{DD} = -24$  V,  $T_{ch} = 25^{\circ}C$  (initial), L = 1.0 mH,  $R_G = 25 \Omega$ ,  $I_{AR} = -8$  A
- Note 4: Repetitive rating: pulse width limited by maximum channel temperature
- Note 5: on lower left of the marking indicates Pin 1.
  - ※ Weekly code: (Three digits)

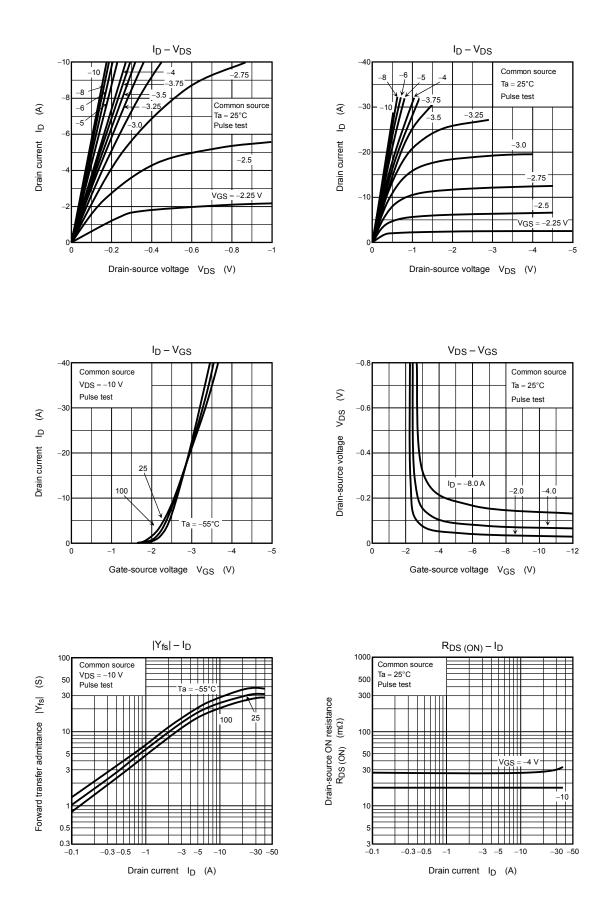


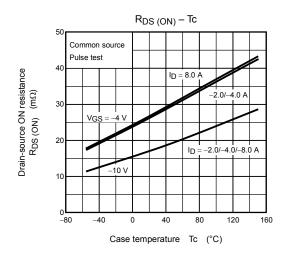
### Electrical Characteristics (Ta = 25°C)

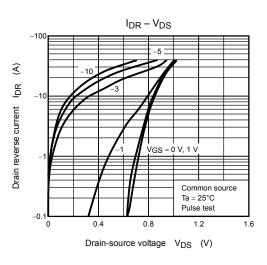
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage current		I <sub>GSS</sub>	$V_{GS}=\pm 16~V,~V_{DS}=0~V$	_	_	±10	μA	
Drain cut-OFF current		I <sub>DSS</sub>	$V_{DS} = -40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		—	-10	μA	
Drain-source breakdown voltage		V (BR) DSS	$I_D = -10$ mA, $V_{GS} = 0$ V	-40	_	_	v	
		V (BR) DSX	$I_D = -10$ mA, $V_{GS} = 20$ V	-25	_	_	v	
Gate threshold voltage		V <sub>th</sub>	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -1 \text{ mA}$	-0.8	_	-2.0	V	
Drain-source ON resistance		Dension	$V_{GS} = -4 V$ , $I_D = -4.0 A$	_	27	35	mΩ	
		R <sub>DS</sub> (ON)	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -4.0 \text{ A}$	_	17	25		
Forward transfer admittance		Y <sub>fs</sub>	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -4.0 \text{ A}$	8	16	_	S	
Input capacitance		C <sub>iss</sub>	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	_	2180	_	pF	
Reverse transfer capacitance		C <sub>rss</sub>		_	275	_		
Output capacitance		C <sub>oss</sub>		_	330	_		
Switching time	Rise time	tr	$V_{GS} \xrightarrow{0}_{-10} V \xrightarrow{I_D = -4} A$		6.0	_	- ns	
	Turn-ON time	t <sub>on</sub>		_	15	_		
	Fall time	t <sub>f</sub>	1	_	30	_		
	Turn-OFF time	t <sub>off</sub>	$V_{DD} \simeq -20 \text{ V}$ Duty $\leq$ 1%, $t_W$ = 10 $\mu s$		115	_		
Total gate charge (gate-source plus gate-drain)		Qg	$V_{DD} \simeq -32 \text{ V}, \text{ V}_{GS} = -10 \text{ V},$	_	48	_	nC	
Gate-source charge 1		Q <sub>gs1</sub>	$I_{\rm D} = -8 \rm{A}$	_	5.5			
Gate-drain ("miller") charge		Q <sub>gd</sub>			12			

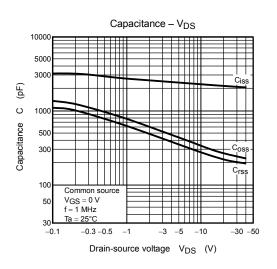
### Source-Drain Ratings and Characteristics (Ta = 25°C)

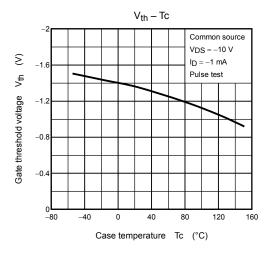
Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit	
Drain reverse current	Pulse	(Note 1)	IDRP	—	_	_	-32	Α
Forward voltage (diode)	)		V <sub>DSF</sub>	$I_{DR} = -8 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$	_		1.2	V

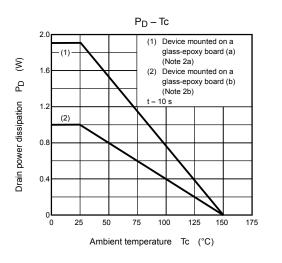


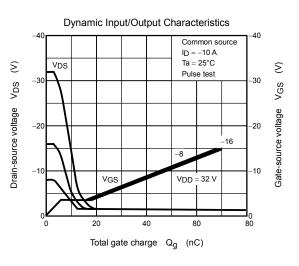


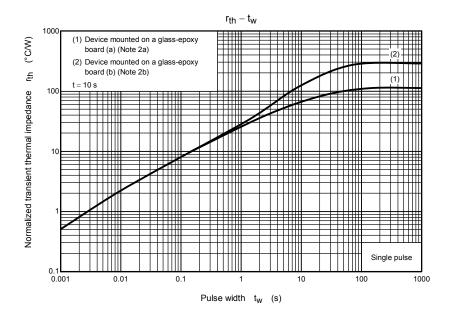


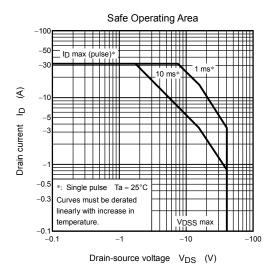












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